#### 12/07/2018 505224973

# PATENT ASSIGNMENT COVER SHEET

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| SUBMISSION TYPE:      | NEW ASSIGNMENT |
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| NATURE OF CONVEYANCE: | ASSIGNMENT     |

#### **CONVEYING PARTY DATA**

| Name            | Execution Date |
|-----------------|----------------|
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| KEITA ISHIKAWA  | 11/15/2018     |
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| KOSUKE HASEGAWA | 11/15/2018     |
| HIDEAKI FUKUDA  | 11/15/2018     |
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## **PROPERTY NUMBERS Total: 1**

| Property Type       | Number   |  |
|---------------------|----------|--|
| Application Number: | 16307538 |  |

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| DATE SIGNED:            | 12/07/2018               |

**Total Attachments: 2** 

**PATENT** REEL: 047704 FRAME: 0045

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> PATENT REEL: 047704 FRAME: 0046

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#### ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each undersigned inventor has sold and assigned, and by these presents hereby sells and assigns, unto

name and address of assignee

MEIDENSHA CORPORATION 1-1, Osaki 2-chome, Shinagawa-ku, Tokyo 141-6029 Japan

(hereinafter ASSIGNEE) all right, title and interest for the United States, its territories and possessions in and to his invention relating to

title of invention

METHOD FOR MANUFACTURING ELECTRODE MATERIAL

as set forth in his/her United States Patent Application

check one

|    | ) | executed concurrently herewith     |                |  |
|----|---|------------------------------------|----------------|--|
|    | ) | executed on                        |                |  |
| ĺΧ | ) | Serial No. PCT/JP2017/010426 Filed | March 15, 2017 |  |

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of this Assignment.

names and signatures of inventors

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Kenta Gamanura date 1/15/2018 Kasuke Hasegawa date 11/15/2018

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**PATENT REEL: 047704 FRAME: 0048** 

**RECORDED: 12/07/2018**